

## Wideband Two Quadrant Analog Multiplier (Voltage Output)

July 1994

### Features

- This Circuit is Processed in Accordance to MIL-STD-883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- High Speed Voltage Output..... 300V/ $\mu$ s (Min)
- Low Multiplication Error .....3.0% (Max)  
1.6% (Typ)
- Input Bias Currents ..... 5 $\mu$ A (Max)  
1.2 $\mu$ A (Typ)
- Signal Input Feedthrough .....-52dB (Typ)
- Wide Signal Bandwidth..... 30MHz (Typ)
- Wide Control Bandwidth..... 17MHz (Typ)
- Gain Flatness to 5MHz..... 0.10dB (Typ)

### Applications

- Military Avionics
- Missile Guidance Systems
- Medical Imaging Displays
- Video Mixers
- Sonar AGC Processors
- Radar Signal Conditioning
- Voltage Controlled Amplifier
- Vector Generator

### Description

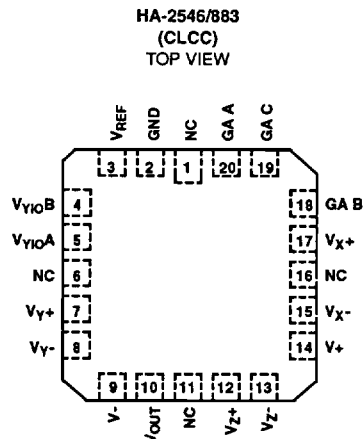
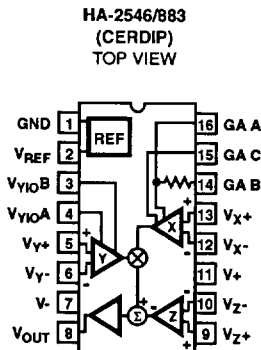
The HA-2546/883 is a monolithic, high speed, two quadrant, analog multiplier constructed in the Harris Dielectrically Isolated High Frequency Process. The HA-2546/883 has a voltage output with a 30MHz signal bandwidth, 300V/ $\mu$ s slew rate and a 17MHz control input bandwidth. High bandwidth and slew rate make this part an ideal component for use in video systems. The suitability for precision video applications is demonstrated further by the 0.1dB gain flatness at 5MHz, 1.6% multiplication error, -52dB feedthrough and differential inputs with 1.2 $\mu$ A bias currents. The HA-2546/883 also has low differential gain (0.1% typ.) and phase (0.1° typ.) errors.

The HA-2546/883 is well suited for AGC circuits as well as mixer applications for sonar, radar, and medical imaging equipment. The voltage output of the HA-2546/883 simplifies many designs by eliminating the current-to-voltage conversion stage required for current output multipliers.

### Ordering Information

PART NUMBER	TEMPERATURE RANGE	PACKAGE
HA1-2546/883	-55°C to +125°C	16 Lead CerDIP
HA4-2546/883	-55°C to +125°C	20 Lead Ceramic LCC

### Pinouts



## Specifications HA-2546/883

### Absolute Maximum Ratings

Voltage Between V+ and V- .....	35V
Differential Input Voltage .....	6V
Output Current .....	60mA
Junction Temperature .....	+175°C
Storage Temperature Range .....	-65°C ≤ T <sub>A</sub> ≤ +150°C
ESD Rating .....	<2000V
Lead Temperature (Soldering 10s) .....	+300°C

### Thermal Information

Thermal Resistance	θ <sub>JA</sub>	θ <sub>JC</sub>
CerDIP Package .....	80°C/W	25°C/W
Ceramic LCC .....	61°C/W	12°C/W
Maximum Package Power Dissipation		
CerDIP Package at +75°C .....	1.25W	
Ceramic LCC Package at +75°C .....	1.64W	
Package Power Dissipation Derating Factor above +75°C		
CerDIP Package .....	12mW/°C	
Ceramic LCC Package .....	16mW/°C	

*CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.*

### Operating Conditions

Operating Temperature Range .....	-55°C to +125°C	Operating Supply Voltage .....	±8V to ±15V
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**TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS**

Device Tested at: V<sub>SUPPLY</sub> = ±15V, R<sub>LOAD</sub> = 1kΩ, C<sub>LOAD</sub> = 50pF, Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROU PS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Multiplication Error	ME	V <sub>Y</sub> = ±5V	1	+25°C	-3	3	%FS
			2, 3	+125°C, -55°C	-5	5	%FS
Scale Factor Error	SF		1	+25°C	-5	5	%
			2, 3	+125°C, -55°C	-5	5	%
Common Mode Range	+CMR		1	+25°C	5	-	V
			2, 3	+125°C, -55°C	5	-	V
	-CMR		1	+25°C	-	-5	V
			2, 3	+125°C, -55°C	-	-5	V
Input Offset Voltage (V <sub>Y</sub> )	V <sub>IO</sub> (V <sub>Y</sub> )	V <sub>CM</sub> = 0V	1	+25°C	-10	10	mV
			2, 3	+125°C, -55°C	-15	15	mV
Input Bias Current (V <sub>Y</sub> )	I <sub>B</sub> (V <sub>Y</sub> )	V <sub>CM</sub> = 0V	1	+25°C	-15	15	μA
			2, 3	+125°C, -55°C	-20	20	μA
Input Offset Current (V <sub>Y</sub> )	I <sub>IO</sub> (V <sub>Y</sub> )	V <sub>CM</sub> = 0V	1	+25°C	-2	2	μA
			2, 3	+125°C, -55°C	-3	3	μA
Common Mode (V <sub>Y</sub> ) Rejection Ratio	+CMRR(V <sub>Y</sub> )	V <sub>Y</sub> = 0 to +5V, V <sub>X</sub> = +2V	1	+25°C	60	-	dB
			2, 3	+125°C, -55°C	60	-	dB
	-CMRR(V <sub>Y</sub> )	V <sub>Y</sub> = 0 to -5V, V <sub>X</sub> = +2V	1	+25°C	60	-	dB
			2, 3	+125°C, -55°C	60	-	dB
Input Offset Voltage (V <sub>X</sub> )	V <sub>IO</sub> (V <sub>X</sub> )	V <sub>CM</sub> = 0V	1	+25°C	-2	2	mV
			2, 3	+125°C, -55°C	-15	15	mV
Input Bias Current (V <sub>X</sub> )	I <sub>B</sub> (V <sub>X</sub> )	V <sub>CM</sub> = 0V	1	+25°C	-2	2	μA
			2, 3	+125°C, -55°C	-5	5	μA
Input Offset Current (V <sub>X</sub> )	I <sub>IO</sub> (V <sub>X</sub> )	V <sub>CM</sub> = 0V	1	+25°C	-2	2	μA
			2, 3	+125°C, -55°C	-3	3	μA
Input Offset Voltage (V <sub>Z</sub> )	V <sub>IO</sub> (V <sub>Z</sub> )	V <sub>X</sub> = 0V, V <sub>Y</sub> = 0V	1	+25°C	-15	15	mV
			2, 3	+125°C, -55°C	-15	15	mV
Output Voltage Swing	+V <sub>OUT</sub>	V <sub>Y</sub> = +5V, V <sub>X</sub> = +2.5V	1	+25°C	5	-	V
			2, 3	+125°C, -55°C	5	-	V
	-V <sub>OUT</sub>	V <sub>Y</sub> = -5V, V <sub>X</sub> = +2.5V	1	+25°C	-	-5	V
			2, 3	+125°C, -55°C	-	-5	V
Output Current	+I <sub>OUT</sub>	V <sub>Y</sub> = +5V, V <sub>X</sub> = +2.5V	1	+25°C	20	-	mA
			2, 3	+125°C, -55°C	20	-	mA
	-I <sub>OUT</sub>	V <sub>Y</sub> = -5V, V <sub>X</sub> = +2.5V	1	+25°C	-	-20	mA
			2, 3	+125°C, -55°C	-	-20	mA

# Specifications HA-2546/883

**TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)**

Device Tested at:  $V_{SUPPLY} = \pm 15V$ ,  $R_{LOAD} = 1k\Omega$ ,  $C_{LOAD} = 50pF$ , Unless Otherwise Specified.

PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUP PS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Power Supply Rejection Ratio	+PSRR	$\Delta V_S = 3V$ , $V_+ = +15V$ , $V_- = -15V$ , $V_+ = +12V$ , $V_- = -15V$	1	+25°C	58	-	dB
			2, 3	+125°C, -55°C	58	-	dB
	-PSRR	$\Delta V_S = 3V$ , $V_+ = +15V$ , $V_- = -15V$ , $V_+ = +15V$ , $V_- = -12V$	1	+25°C	58	-	dB
			2, 3	+125°C, -55°C	58	-	dB
Quiescent Power Supply Current	+I <sub>CC</sub>	$V_X = V_Y = 0V$ , $I_{OUT} = 0mA$	1	+25°C	29	-	mA
			2, 3	+125°C, -55°C	29	-	mA
	-I <sub>CC</sub>	$V_X = V_Y = 0V$ , $I_{OUT} = 0mA$	1	+25°C	-	-29	mA
			2, 3	+125°C, -55°C	-	-29	mA

**TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS**

Table 2 Intentionally Left Blank. See AC Specifications in Table 3.

**TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS**

Device Tested at:  $V_{SUPPLY} = \pm 15V$ ,  $R_{LOAD} = 1k\Omega$ ,  $C_{LOAD} = 50pF$ , Unless Otherwise Specified.

PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Slew Rate	+SR	$V_{OUT} = -5V$ to $+5V$ , $V_X = 2V_{DC}$	1	+25°C	300	-	V/μs
			1	+125°C, -55°C	300	-	V/μs
	-SR	$V_{OUT} = +5V$ to $-5V$ , $V_X = 2V_{DC}$	1	+25°C	300	-	V/μs
			1	+125°C, -55°C	300	-	V/μs
Rise and Fall Time	TR	$V_{OUT} = -100mV$ to $+100mV$ $V_X = 2V_{DC}$	1, 3	+25°C	-	15	ns
			1, 3	+125°C, -55°C	-	17	ns
	TF	$V_{OUT} = +100mV$ to $-100mV$ $V_X = 2V_{DC}$	1, 3	+25°C	-	15	ns
			1, 3	+125°C, -55°C	-	17	ns
Overshoot	+OS	$V_{OUT} = -100mV$ to $+100mV$ $V_X = 2V_{DC}$	1	+25°C	-	30	%
			1	+125°C, -55°C	-	30	%
	-OS	$V_{OUT} = +100mV$ to $-100mV$ $V_X = 2V_{DC}$	1	+25°C	-	30	%
			1	+125°C, -55°C	-	30	%
Full Power Bandwidth	FPBW	$V_{PEAK} = 5V$ , $V_X = 2V_{DC}$	1, 2	+25°C	9.5	-	MHz
			1, 2	+125°C, -55°C	9.5	-	MHz

NOTES:

- Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot to lot and within lot variation.
- Full Power Bandwidth guarantee based on Slew Rate measurement using  $FPBW = \text{Slew Rate} / (2\pi V_{PEAK})$ .
- Measured between 10% and 90% points.

**TABLE 4. ELECTRICAL TEST REQUIREMENTS**

MIL-STD-883 TEST REQUIREMENTS	SUBGROUPS (SEE TABLE 1)
Interim Electrical Parameters (Pre Burn-in)	1
Final Electrical Test Parameters	1(Note 1), 2, 3
Group A Test Requirements	1, 2, 3
Groups C and D Endpoints	1

NOTE:

- PDA applies to Subgroup 1 only.

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ANALOG  
MULTIPLIERS

**Die Characteristics**

**DIE DIMENSIONS:**

79.9mils x 119.7mils x 19mils ± 1mils

**METALLIZATION:**

Type: Al, 1%Cu

Thickness: 16kÅ ± 2kÅ

**GLASSIVATION:**

Type: Nitride (Si<sub>3</sub>N<sub>4</sub>) over Silox (SiO<sub>2</sub>, 5% Phos)

Silox Thickness: 12kÅ ± 1.5kÅ

Nitride Thickness: 3.5kÅ ± 1.5kÅ

**WORST CASE CURRENT DENSITY:**

0.72 x 10<sup>5</sup> A/cm<sup>2</sup>

**TRANSISTOR COUNT: 87**

**Metallization Mask Layout**

